



Hostaform® XGC25-LW01 XAP® is an injection molding grade reinforced with approximately 25% glass fibers and tribological modification for sliding applications requiring low friction and wear.

### **Product information**

| Resin Identification Part Marking Code   | POM-GF25<br>>POM-GF25<                          |                          | ISO 1043<br>ISO 11469   |
|--|---|--------------------------|---|
| Rheological properties   |   |                          |   |
| Moulding shrinkage, parallel<br>Moulding shrinkage, normal   | 0.8<br>0.9                                      |                          | ISO 294-4, 2577<br>ISO 294-4, 2577  |
| Typical mechanical properties  |   |                          |   |
| Tensile modulus Tensile stress at break, 5mm/min Tensile strain at break, 5mm/min Flexural modulus Charpy impact strength, 23°C Charpy notched impact strength, 23°C Poisson's ratio | 3.5<br>8000<br>60                               | MPa<br>%                 | ISO 527-1/-2<br>ISO 527-1/-2<br>ISO 527-1/-2<br>ISO 178<br>ISO 179/1eU<br>ISO 179/1eA |
| [C]: Calculated  | 0.34  |                          |   |
| Thermal properties   |   |                          |   |
| Melting temperature, 10°C/min<br>Temperature of deflection under load, 1.8 MPa<br>Coefficient of linear thermal expansion<br>(CLTE), parallel  | 166<br>160<br>60                                |                          | ISO 11357-1/-3<br>ISO 75-1/-2<br>ISO 11359-1/-2                                       |
| Coefficient of linear thermal expansion (CLTE), normal  Physical/Other properties  | 110   | E-6/K                    | ISO 11359-1/-2  |
| Density  | 1520  | kg/m³                    | ISO 1183  |
| Injection  |   |                          |   |
| Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature               | no<br>100<br>3 - 4<br>≤0.2<br>200<br>190<br>210 | h<br>%<br>°C<br>°C<br>°C |   |
| Screw tangential speed Mold Temperature Optimum Min. mould temperature Max. mould temperature  | ≤0.3<br>100<br>80<br>120                        | °C                       |   |

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60 - 120 MPa

2 MPa

Revised: 2024-07-08 Source: Celanese Materials Database

Hold pressure range Back pressure





#### Characteristics

Processing Injection Moulding

Special characteristics Low wear / Low friction, Low emissions

Additional information

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

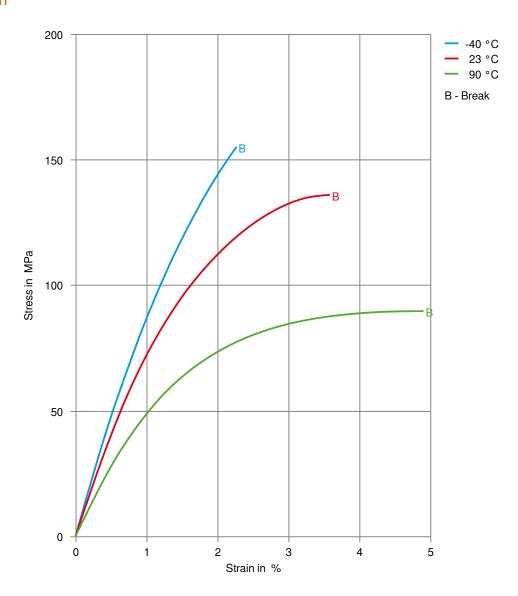
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### Stress-strain



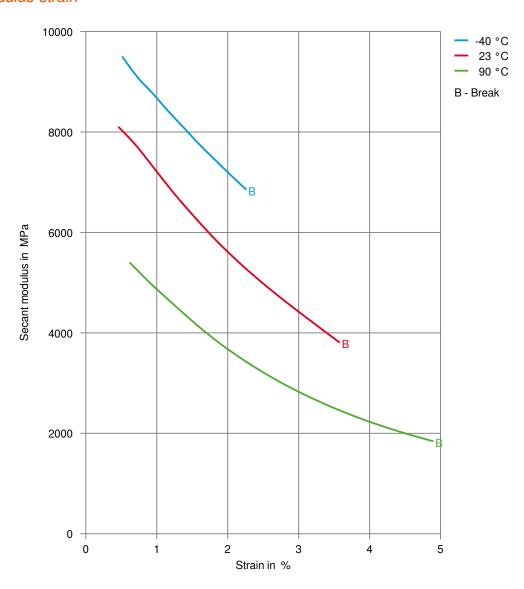
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#### Secant modulus-strain



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